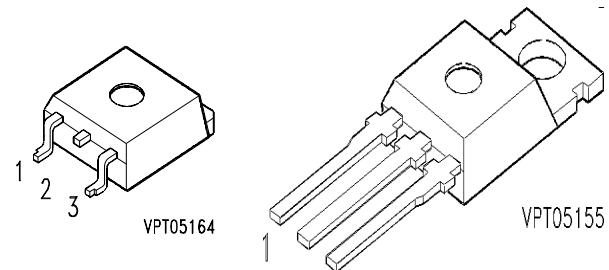


#### SIPMOS® Power Transistor

- N channel
- Enhancement mode
- Avalanche-rated
- dv/dt rated
- 175°C operating temperature
- also in SMD available



Pin 1	Pin 2	Pin 3
G	D	S

Type	$V_{DS}$	$I_D$	$R_{DS(on)}$	Package	Ordering Code
BUZ 104 S	55 V	13.5 A	0.1 Ω	TO-220 AB	Q67040-S4007-A2

#### Maximum Ratings

Parameter	Symbol	Values	Unit
Continuous drain current $T_C = 25^\circ\text{C}$	$I_D$	13.5	A
$T_C = 100^\circ\text{C}$		9.6	
Pulsed drain current $T_C = 25^\circ\text{C}$	$I_{D\text{puls}}$	54	
Avalanche energy, single pulse $I_D = 13.5 \text{ A}, V_{DD} = 25 \text{ V}, R_{GS} = 25 \Omega$ $L = 571 \mu\text{H}, T_j = 25^\circ\text{C}$	$E_{AS}$	52	mJ
Avalanche current, limited by $T_{j\text{max}}$	$I_{AR}$	13.5	A
Avalanche energy, periodic limited by $T_{j\text{max}}$	$E_{AR}$	3.5	mJ
Reverse diode dv/dt $I_S = 13.5 \text{ A}, V_{DS} = 40 \text{ V}, dI_F/dt = 200 \text{ A}/\mu\text{s}$ $T_{j\text{max}} = 175^\circ\text{C}$	dv/dt	6	kV/μs
Gate source voltage	$V_{GS}$	± 20	V
Power dissipation $T_C = 25^\circ\text{C}$	$P_{\text{tot}}$	35	W

**Maximum Ratings**

Parameter	Symbol	Values	Unit
Operating temperature	$T_j$	-55 ... + 175	°C
Storage temperature	$T_{stg}$	-55 ... + 175	
Thermal resistance, junction - case	$R_{thJC}$	$\leq 4.3$	K/W
Thermal resistance, junction - ambient	$R_{thJA}$	$\leq 62$	
IEC climatic category, DIN IEC 68-1		55 / 175 / 56	

**Electrical Characteristics**, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

**Static Characteristics**

Drain- source breakdown voltage $V_{GS} = 0 \text{ V}$ , $I_D = 0.25 \text{ mA}$ , $T_j = 25^\circ\text{C}$	$V_{(BR)DSS}$	55	-	-	V
Gate threshold voltage $V_{GS}=V_{DS}$ , $I_D = 20 \mu\text{A}$	$V_{GS(\text{th})}$	2.1	3	4	
Zero gate voltage drain current $V_{DS} = 50 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $T_j = -40^\circ\text{C}$	$I_{DSS}$	-	-	0.1	$\mu\text{A}$
$V_{DS} = 50 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $T_j = 25^\circ\text{C}$		-	0.1	1	
$V_{DS} = 50 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $T_j = 150^\circ\text{C}$		-	-	100	
Gate-source leakage current $V_{GS} = 20 \text{ V}$ , $V_{DS} = 0 \text{ V}$	$I_{GSS}$	-	10	100	nA
Drain-Source on-resistance $V_{GS} = 10 \text{ V}$ , $I_D = 9.6 \text{ A}$	$R_{DS(\text{on})}$	-	0.076	0.1	$\Omega$

**Electrical Characteristics**, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

### Dynamic Characteristics

Transconductance $V_{DS} \geq 2 * I_D * R_{DS(on)max}, I_D = 9.6 \text{ A}$	$g_{fs}$	4	-	-	S
Input capacitance $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	$C_{iss}$	-	270	340	pF
Output capacitance $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	$C_{oss}$	-	95	120	
Reverse transfer capacitance $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	$C_{rss}$	-	50	65	
Turn-on delay time $V_{DD} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 13.5 \text{ A}$ $R_G = 33 \Omega$	$t_{d(on)}$	-	9	15	ns
Rise time $V_{DD} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 13.5 \text{ A}$ $R_G = 33 \Omega$	$t_r$	-	22	35	
Turn-off delay time $V_{DD} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 13.5 \text{ A}$ $R_G = 33 \Omega$	$t_{d(off)}$	-	18	30	
Fall time $V_{DD} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 13.5 \text{ A}$ $R_G = 33 \Omega$	$t_f$	-	16.5	25	
Gate charge at threshold $V_{DD} = 40 \text{ V}, I_D = 0.1 \text{ A}, V_{GS} = 0 \text{ to } 1 \text{ V}$	$Q_{g(th)}$	-	0.33	0.5	nC
Gate charge at 7.0 V $V_{DD} = 40 \text{ V}, I_D = 13.5 \text{ A}, V_{GS} = 0 \text{ to } 7 \text{ V}$	$Q_{g(7)}$	-	7.11	11	
Gate charge total $V_{DD} = 40 \text{ V}, I_D = 13.5 \text{ A}, V_{GS} = 0 \text{ to } 10 \text{ V}$	$Q_{g(total)}$	-	9.5	14	
Gate plateau voltage $V_{DD} = 40 \text{ V}, I_D = 13.5 \text{ A}$	$V_{(plateau)}$	-	5.9	-	V

**Electrical Characteristics**, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified

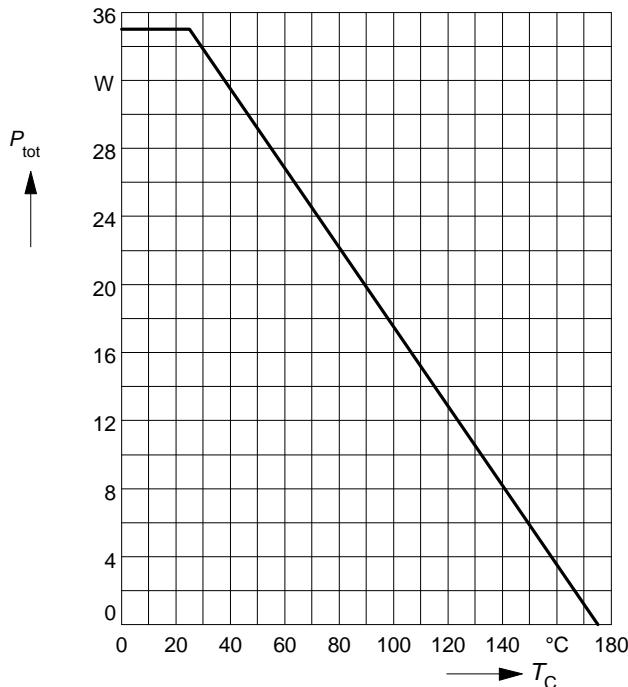
Parameter	Symbol	Values			Unit
		min.	typ.	max.	

**Reverse Diode**

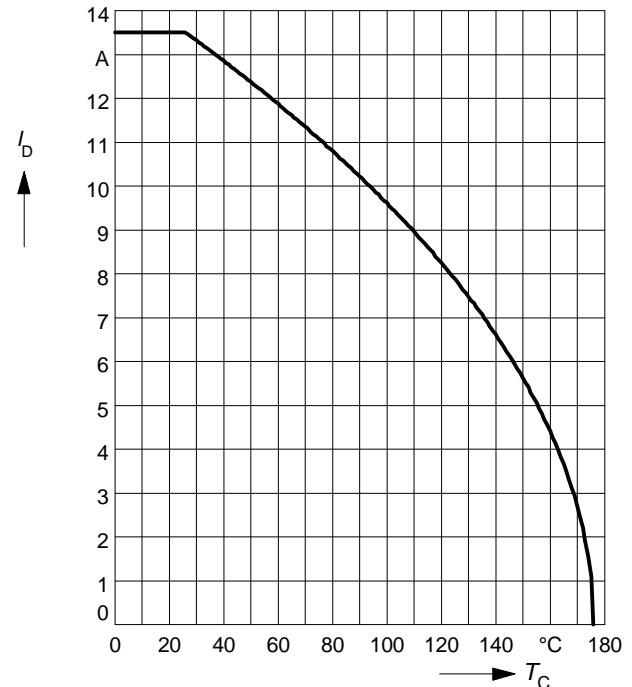
Inverse diode continuous forward current $T_C = 25^\circ\text{C}$	$I_S$	-	-	13.5	A
Inverse diode direct current,pulsed $T_C = 25^\circ\text{C}$	$I_{SM}$	-	-	54	
Inverse diode forward voltage $V_{GS} = 0 \text{ V}, I_F = 27 \text{ A}$	$V_{SD}$	-	1.17	1.8	V
Reverse recovery time $V_R = 30 \text{ V}, I_F=I_S, di_F/dt = 100 \text{ A}/\mu\text{s}$	$t_{rr}$	-	50	75	ns
Reverse recovery charge $V_R = 30 \text{ V}, I_F=I_S, di_F/dt = 100 \text{ A}/\mu\text{s}$	$Q_{rr}$	-	0.1	0.15	$\mu\text{C}$

**Power dissipation**

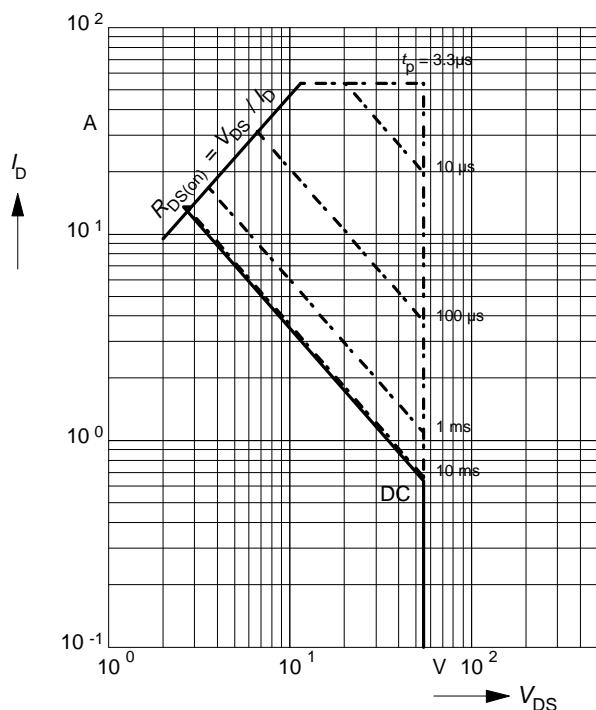
$$P_{\text{tot}} = f(T_C)$$


**Drain current**

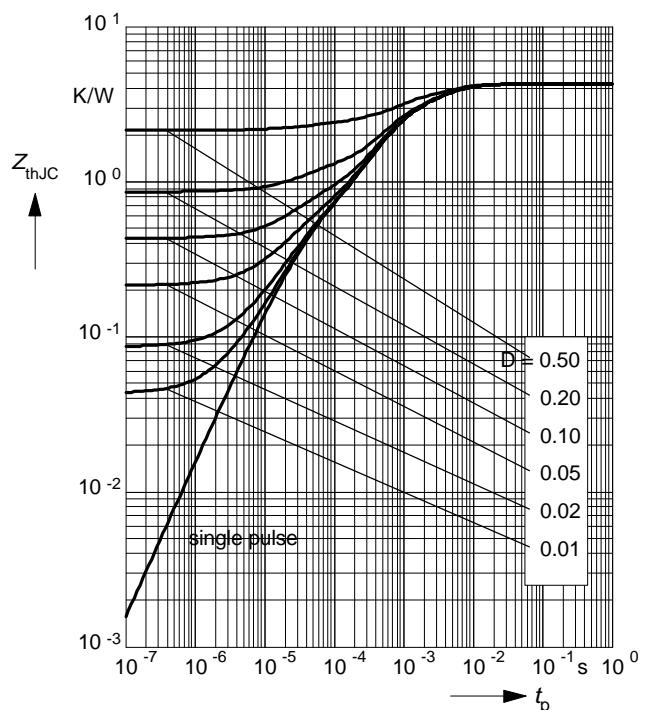
$$I_D = f(T_C)$$

 parameter:  $V_{GS} \geq 10$  V

**Safe operating area**

$$I_D = f(V_{DS})$$

 parameter:  $D = 0$ ,  $T_C = 25^\circ\text{C}$ 

**Transient thermal impedance**

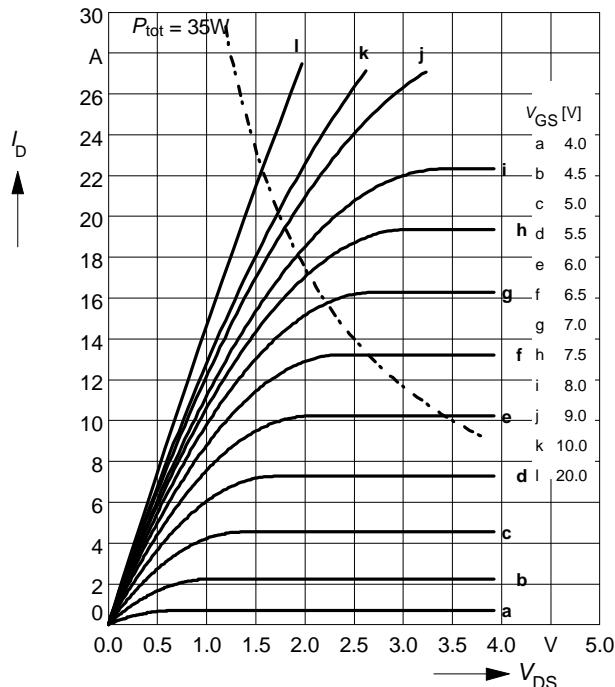
$$Z_{\text{thJC}} = f(t_p)$$

 parameter:  $D = t_p / T$ 


**Typ. output characteristics**

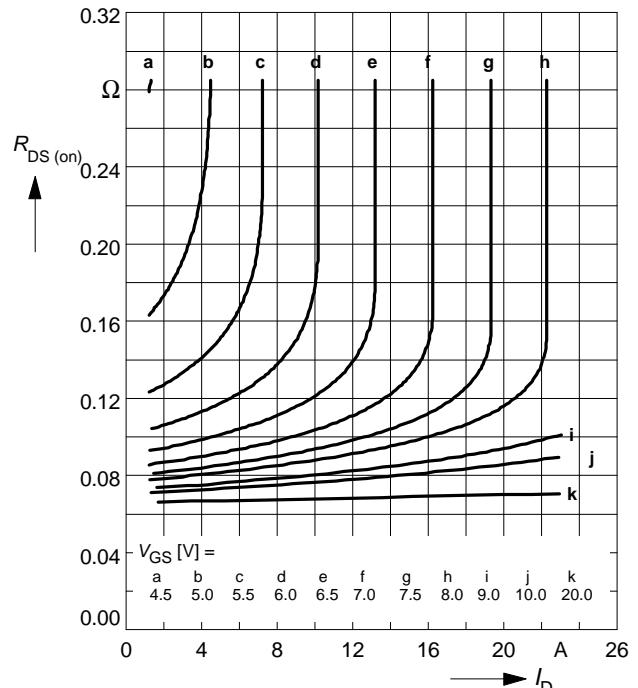
$$I_D = f(V_{DS})$$

parameter:  $t_p = 80 \mu\text{s}$ ,  $T_j = 25^\circ\text{C}$


**Typ. drain-source on-resistance**

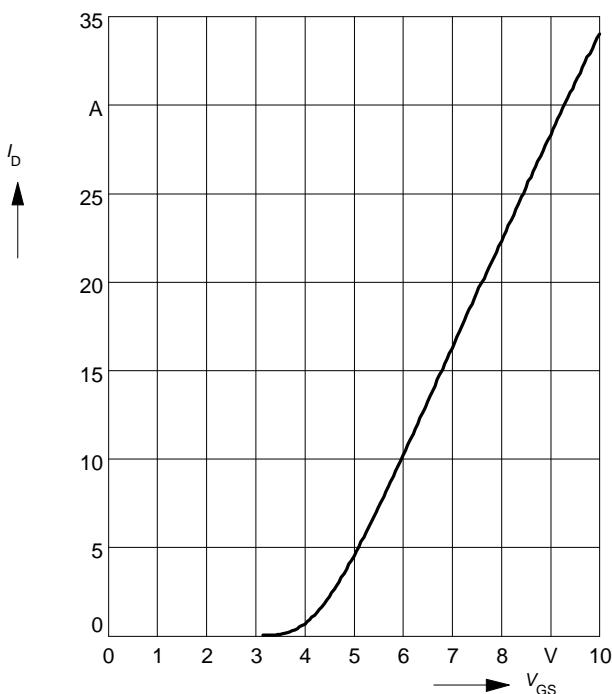
$$R_{DS(on)} = f(I_D)$$

parameter:  $t_p = 80 \mu\text{s}$ ,  $T_j = 25^\circ\text{C}$


**Typ. transfer characteristics  $I_D = f(V_{GS})$** 

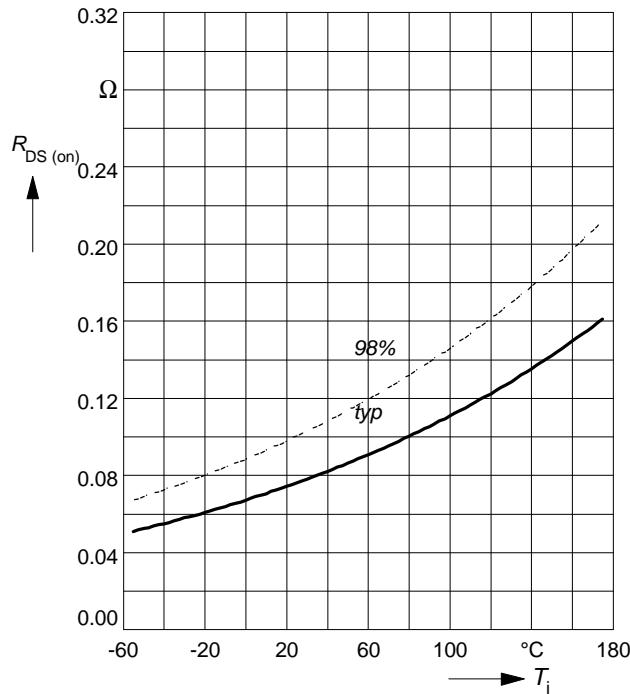
parameter:  $t_p = 80 \mu\text{s}$

$$V_{DS} \geq 2 \times I_D \times R_{DS(on)\max}$$



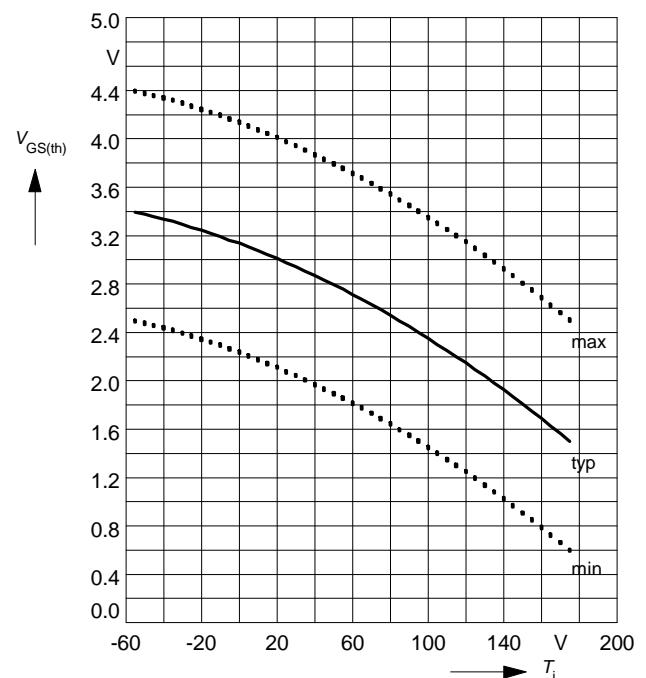
#### Drain-source on-resistance

$R_{DS(on)} = f(T_j)$   
parameter:  $I_D = 9.6 \text{ A}$ ,  $V_{GS} = 10 \text{ V}$



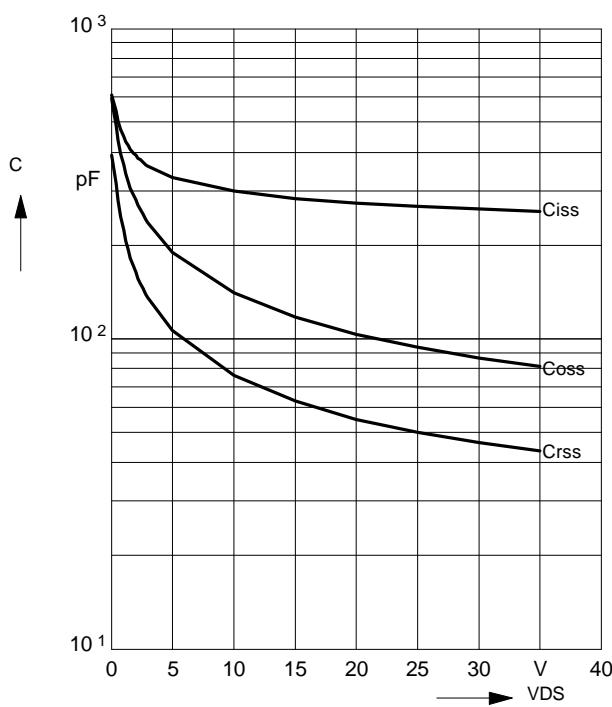
#### Gate threshold voltage

$V_{GS(th)} = f(T_j)$   
parameter:  $V_{GS} = V_{DS}$ ,  $I_D = 20 \mu\text{A}$



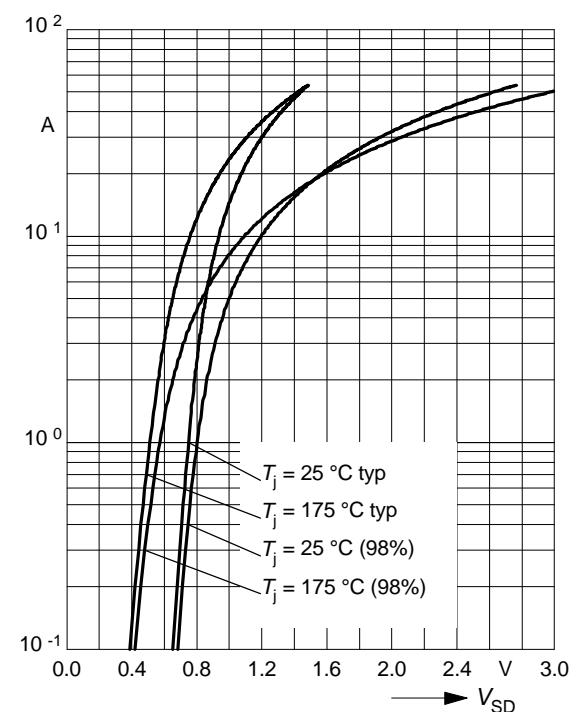
#### Typ. capacitances

$C = f(V_{DS})$   
parameter:  $V_{GS} = 0 \text{ V}$ ,  $f = 1 \text{ MHz}$



#### Forward characteristics of reverse diode

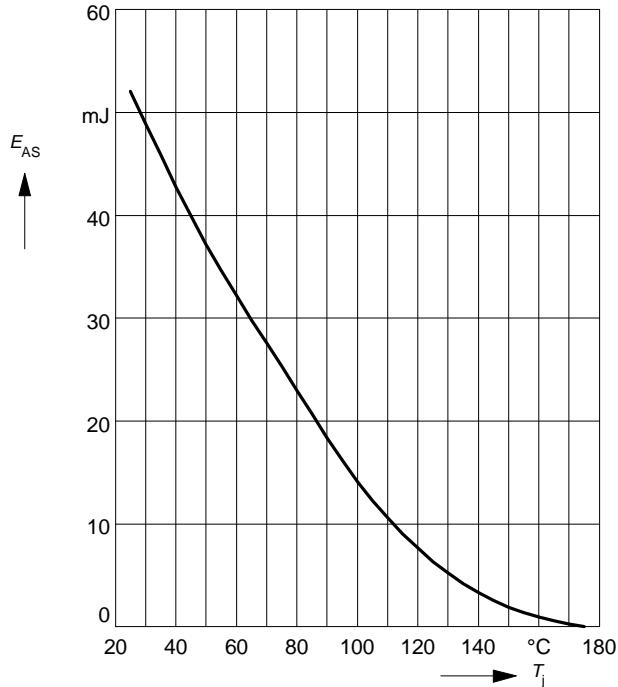
$I_F = f(V_{SD})$   
parameter:  $T_j$ ,  $t_p = 80 \mu\text{s}$



**Avalanche energy**  $E_{AS} = f(T_j)$

parameter:  $I_D = 13.5 \text{ A}$ ,  $V_{DD} = 25 \text{ V}$

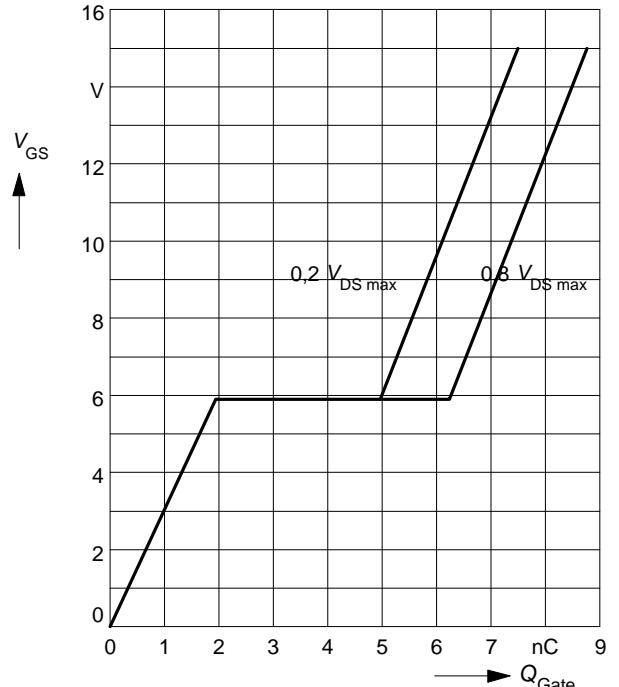
$R_{GS} = 25 \Omega$ ,  $L = 571 \mu\text{H}$



**Typ. gate charge**

$V_{GS} = f(Q_{Gate})$

parameter:  $I_D \text{ puls} = 14 \text{ A}$



**Drain-source breakdown voltage**

$V_{(BR)DSS} = f(T_j)$

